### DESCRIPTION

The SPN4402 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching.

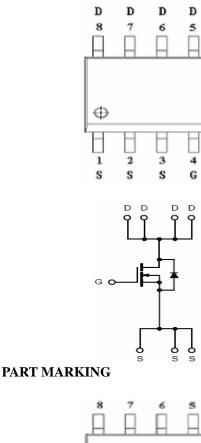
#### FEATURES

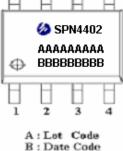
- $30V/12A,RDS(ON) = 13m\Omega@VGS = 10V$
- $30V/10A,RDS(ON) = 18m\Omega@VGS = 4.5V$
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ◆ SOP 8P package design

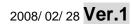
#### APPLICATIONS

- Power Management in Note book
- Battery Powered System
- DC/DC Converter
- Load Switch
- LCD Display inverter

#### PIN CONFIGURATION(SOP - 8P)







PIN DESCRIPTION							
Pin	Symbol	Description					
1	S	Source					
2	S	Source					
3	S	Source					
4	G	Gate					
5	D	Drain					
6	D	Drain					
7	D	Drain					
8	D	Drain					

#### **ORDERING INFORMATION**

Part Number	Package	Part Marking
SPN4402S8RG	SOP- 8P	SPN4402
SPN4402S8TG	SOP- 8P	SPN4402

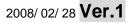
\* SPN4402S8RG : 13" Tape Reel ; Pb – Free

X SPN4402S8TG : Tube ; Pb – Free

### ABSOULTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

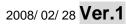
Parameter	Symbol	Typical	Unit		
Drain-Source Voltage	VDSS	30	V		
Gate –Source Voltage	VGSS	±20	V		
Continuous Drain Current( $T_{1}=150^{\circ}$ C)	TA=25°C	In	12	٨	
Continuous Drain Current(TJ=150°C)	Та=70°С	ID	10	A	
Pulsed Drain Current	Ідм	30	А		
Continuous Source Current(Diode Conduction	Is	2.3	А		
Down Dissinction	TA=25°C	Dr	2.5	W	
Power Dissipation	Ta=70°C	PD PD	1.6	w	
Operating Junction Temperature	τJ	-55/150	°C		
Storage Temperature Range	Tstg	-55/150	°C		
Thermal Resistance-Junction to Ambient	Rөја	80	°C/W		



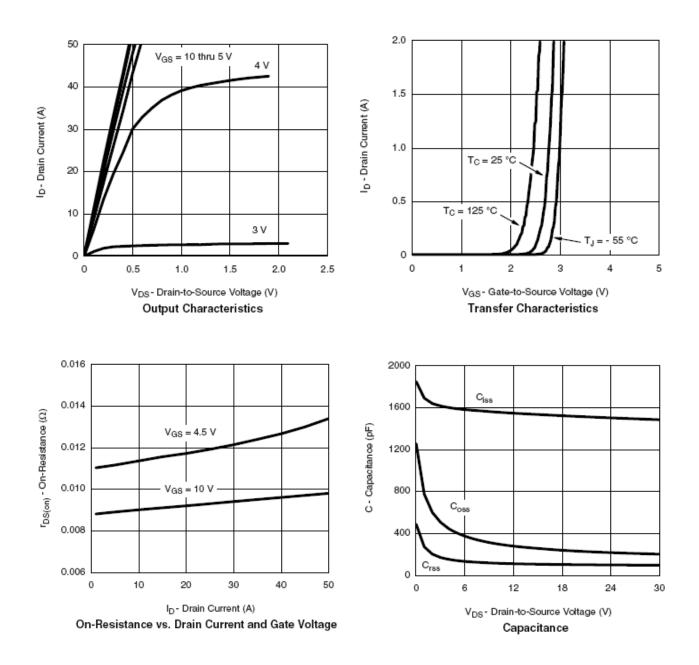
### ELECTRICAL CHARACTERISTICS

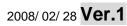
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static						4	
Drain-Source Breakdown Voltage	V(BR)DSS	VGs=0V,ID=250uA	30			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	1.0		3.0	v	
Gate Leakage Current	IGSS	VDS=0V,VGS=±20V			±100	nA	
		VDS=24V,VGS=0V			1	uA	
Zero Gate Voltage Drain Current	IDSS	VDS=24V,VGS=0V TJ=85℃			5		
On-State Drain Current	ID(on)	VDS≥5V,VGS =10V	25			Α	
Drain-Source On-Resistance	RDS(on)	VGs=10V,ID=12A		0.010	0.013	Ω	
Dram-Source On-Resistance	KDS(on)	VGS=4.5V,ID=10A		0.013	0.018	52	
Forward Transconductance	gfs	VDS=15V,ID=6.2A		13		S	
Diode Forward Voltage	VSD	Is=2.3A,VGs =0V		0.8	1.2	V	
Dynamic							
Total Gate Charge	Qg			16	24	nC	
Gate-Source Charge	Qgs	$V_{DS}=15V, V_{GS}=10V$ ID= 2A		4.2			
Gate-Drain Charge	Qgd			2.5		1	
Input Capacitance	Ciss			1350			
Output Capacitance	Coss	VDS=15VGS=0V f=1MHz		258		pF	
Reverse Transfer Capacitance	Crss	1 11/11/2		150			
Turn-On Time	td(on)			15	20	nS	
	tr	$V_{DD}=15V, RL=15\Omega$		6	16		
Turne Off Times	td(off)	ID=5.0A,VGEN=10V RG=1 $\Omega$		20	40		
Turn-Off Time	tſ	]		12	20		

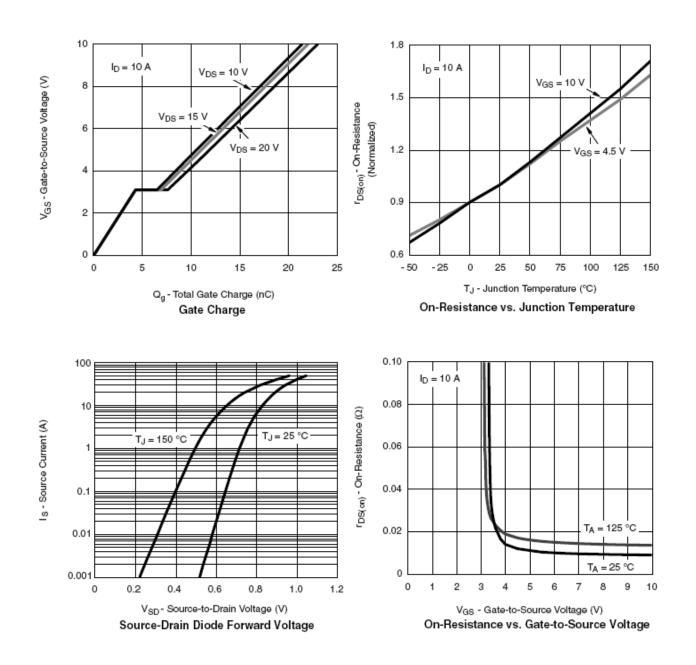


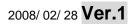
TYPICAL CHARACTERISTICS



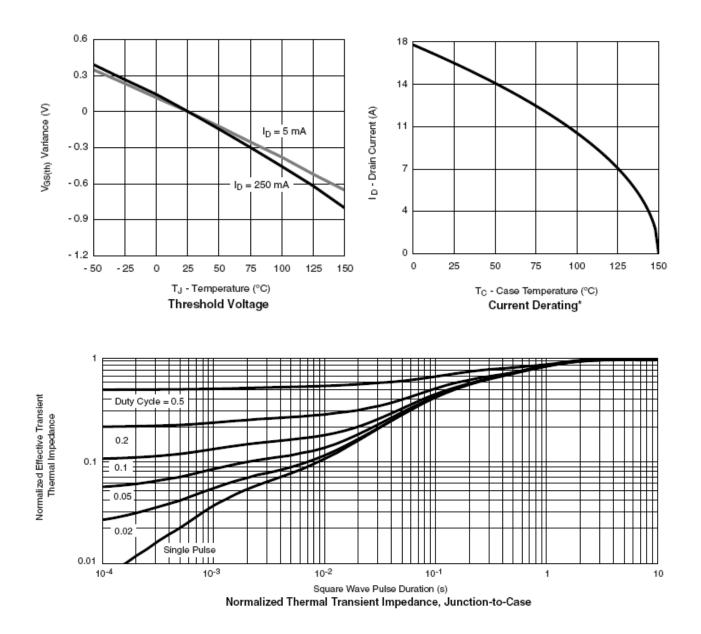


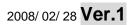
TYPICAL CHARACTERISTICS



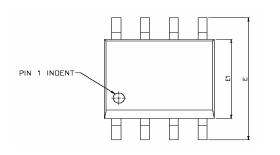


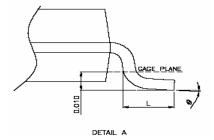
TYPICAL CHARACTERISTICS

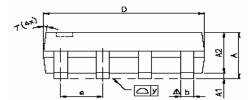


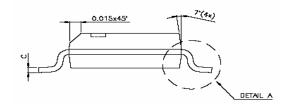


### SOP- 8 PACKAGE OUTLINE









0.445.04.0	DIMENSIONS IN MILLIMETERS		DIMENSIONS IN INCHES			
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10		0.25	0.004		0.010
A2		1.45			0.057	
b	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
L	0.38	0.71	1.27	0.015	0.028	0.050
∕ду			0.076			0.003
0	0*		8'	0.		8'





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